

AIP0630MB Series

Data Sheet

Product Name	AIP0630MB Series
Series	Molding Power Inductor
Size	0630
Version	A4

Molding Power Inductor

Scope

Features

- ROHS, Halogen Free and REACH compliance
- Flux shielded structure
- High rated current
- 125 °C maximum total temperature operation
- 7.3x6.8x3.0 mm maximum surface mount package
- Low core loss
- Ultra low buzz noise due to molding construction

Applications

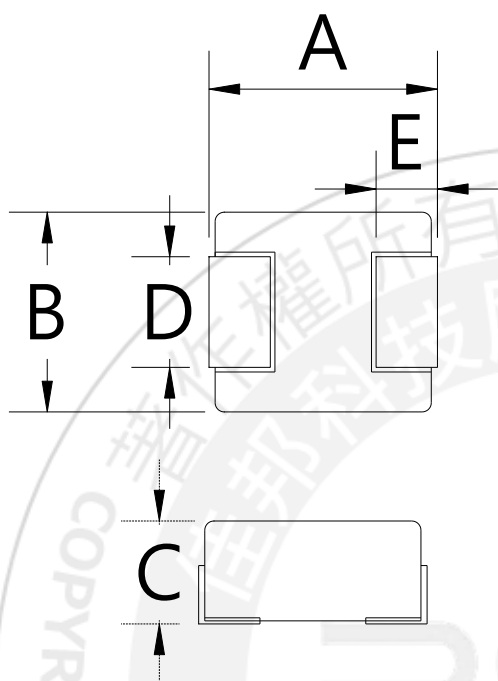
- Laptops and PCs
- Switch and servers
- Base stations
- DC / DC converters
- SSD modules
- Battery powered devices

Explanation of Part Number

A I P 0 6 3 0 M B - 2 2 0 M

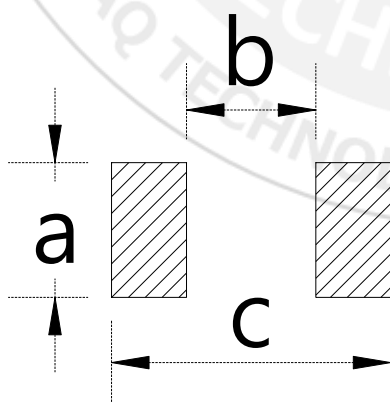


Dimensions



Code	Dimensions[mm]
A	7.0±0.3
B	6.6±0.2
C	2.8±0.2
D	3.0±0.3
E	1.6±0.3

Recommended land pattern



Code	Dimensions[mm]
a	3.5
b	3.7
c	8.4

Marking

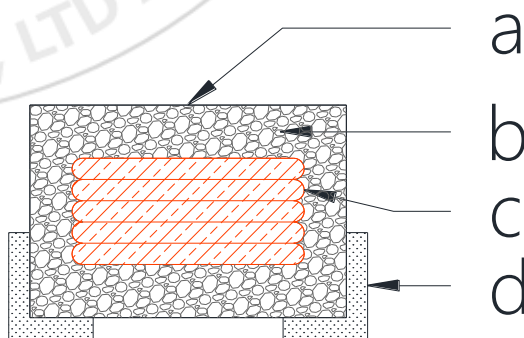
The inductor is marked with a 3-digit code (using ink for marking).

Example: R24 means 0.24 μ H
1R0 means 1.0 μ H
100 means 10 μ H



Structure and Components

Symbo	Component	Material
a	Marking	Ink (black)
b	Core	Alloy sponge powder
c	Wire	Polyurethane copper wire
d	Terminal	Copper plated with Sn



Specifications

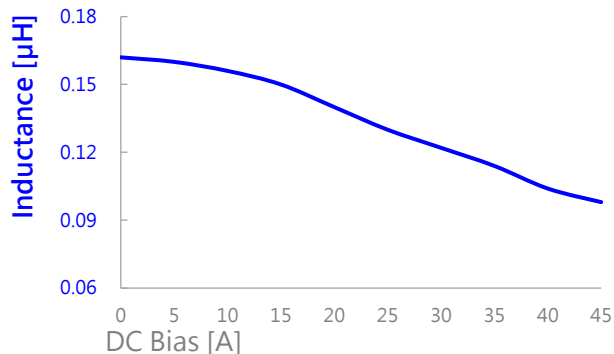
6x6 Series PN	Li [μ H]	Rdc [$m\Omega$]		Isat [A]		Irms [A]	
	Initial Value +/-20%	DC resistance typ.	max.	Li drop 30% typ.	max.	Temp. rising 40°C typ.	max.
AIP0630MB-R15M	0.15	1.8	2.4	41	35	30	25
AIP0630MB-R22M	0.22	2.3	3	35	32	25	21
AIP0630MB-R33M	0.33	2.7	3.3	26	22	22	20
AIP0630MB-R47M	0.47	3.48	4.1	21	17.8	18	16
AIP0630MB-R56M	0.56	3.88	4.5	20	16	16.5	15
AIP0630MB-R68M	0.68	4.75	5.3	19	15	16	14.5
AIP0630MB-R82M	0.82	5.38	6	17	14	14	13
AIP0630MB-1R0M	1.0	6.6	7.25	16.5	13.5	13	11.2
AIP0630MB-1R2M	1.2	7.7	8.6	14.5	12.5	11.7	10.1
AIP0630MB-1R5M	1.5	9.1	10.5	14.2	12	12	9.5
AIP0630MB-2R2M	2.2	13.4	15	12.5	10.5	9.5	8
AIP0630MB-3R3M	3.3	17.9	22	9.6	8.5	8.5	6.2
AIP0630MB-4R7M	4.7	27.9	33	9.2	8.1	6	5.5
AIP0630MB-5R6M	5.6	39	42	6.5	5.2	5.7	5
AIP0630MB-6R8M	6.8	42	48	6.3	5	5	4.2
AIP0630MB-8R2M	8.2	53.9	60	6	4.9	4.7	3.8
AIP0630MB-100M	10	60	68	5.6	4.9	4.5	3.5
AIP0630MB-150M	15	100	113	4.2	3.5	3	2.4
AIP0630MB-220M	22	140	170	3.1	2.5	2.5	2
AIP0630MB-330M	33	195	270	2.5	2	2.1	1.8
AIP0630MB-470M	47	340	385	2.2	1.8	1.5	1.2

Notes

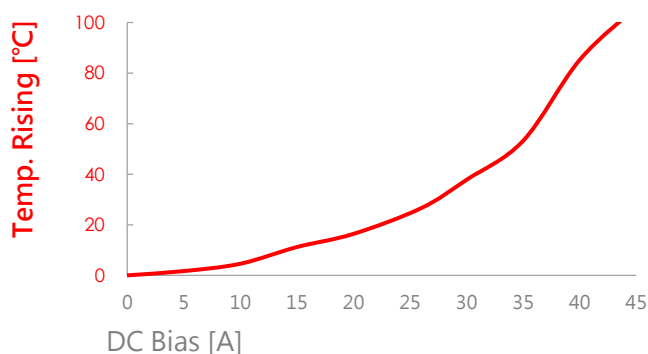
1. Test environment of all data is referenced to 25 °C ambient.
2. Test conditions: 100 KHz, 1Vrms.
3. Isat : DC current (A) that will cause L to drop approximately 30 %.
4. Irms : DC current (A) that will cause an approximate ΔT of 40 °C (reference ambient temperature is 25°C).
5. Operating temperature range – 55 °C to + 125 °C.
6. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

Typical Performance Curves

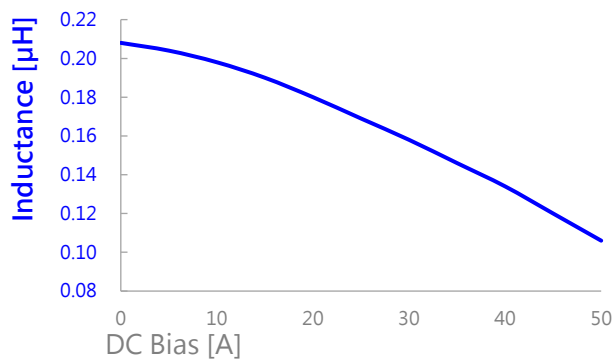
AIP0630MB-R15M



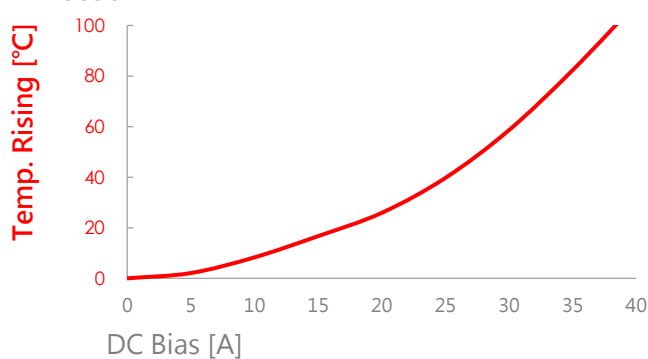
AIP0630MB-R15M



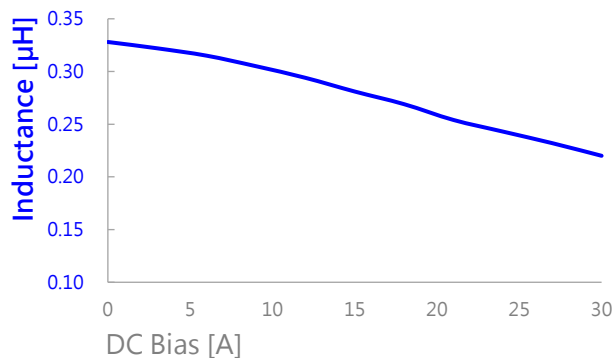
AIP0630MB-R22M



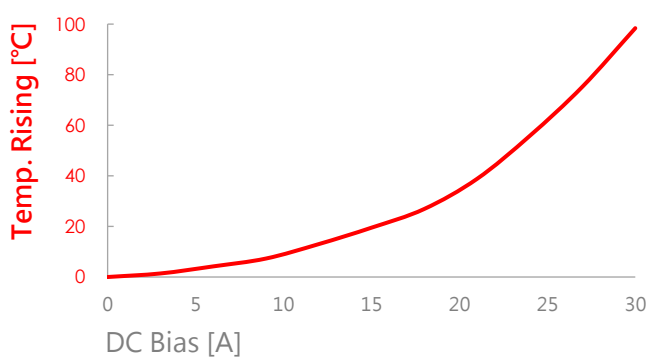
AIP0630MB-R22M



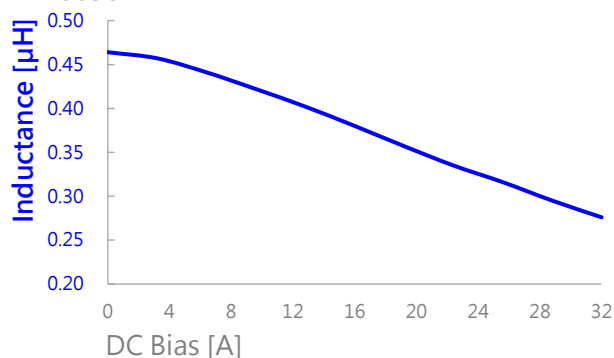
AIP0630MB-R33M



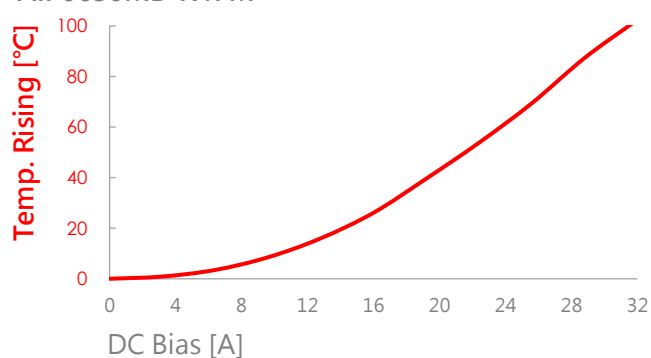
AIP0630MB-R33M



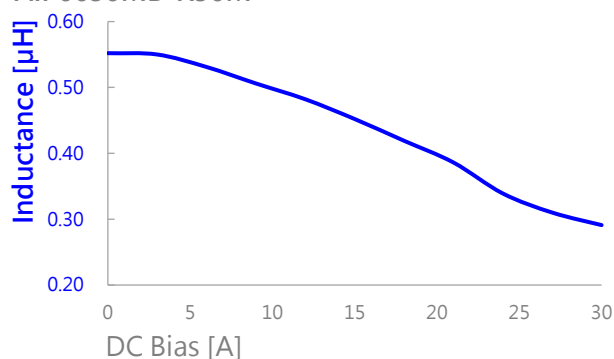
AIP0630MB-R47M



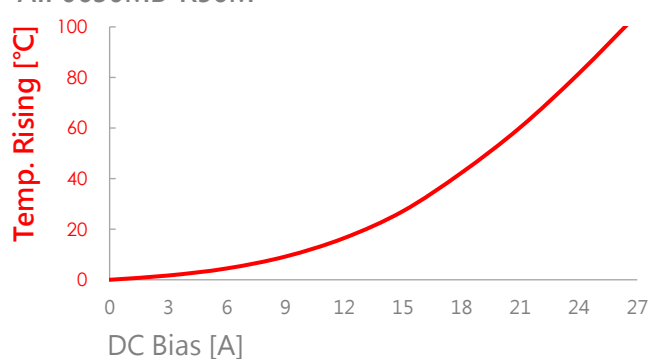
AIP0630MB-R47M



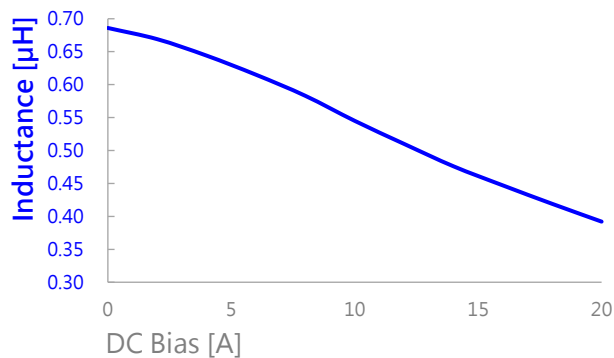
AIP0630MB-R56M



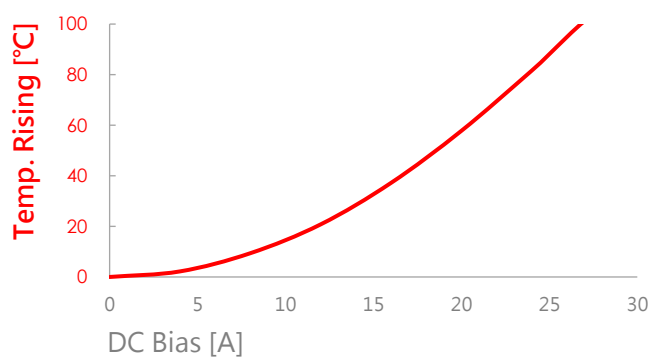
AIP0630MB-R56M



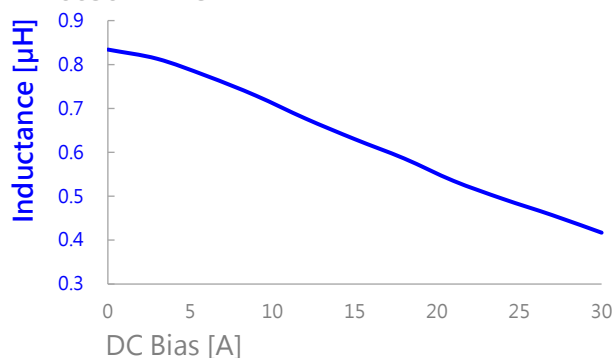
AIP0630MB-R68M



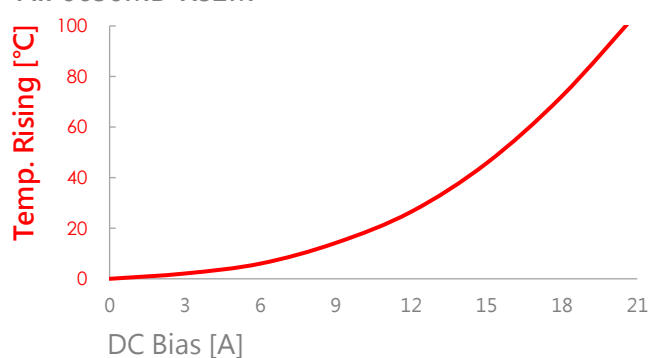
AIP0630MB-R68M



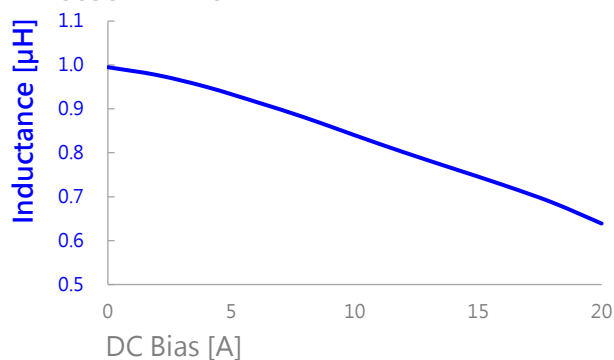
AIP0630MB-R82M



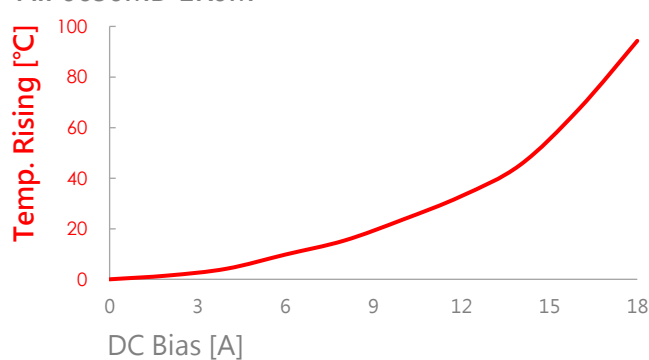
AIP0630MB-R82M



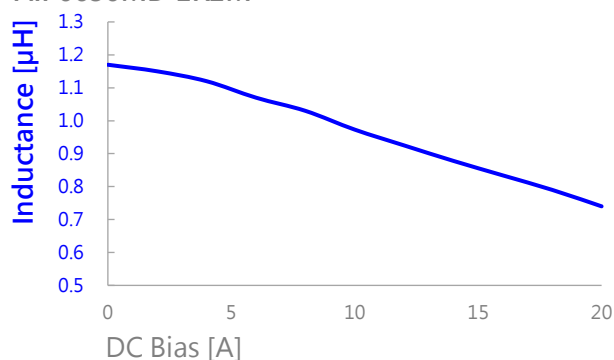
AIP0630MB-1R0M



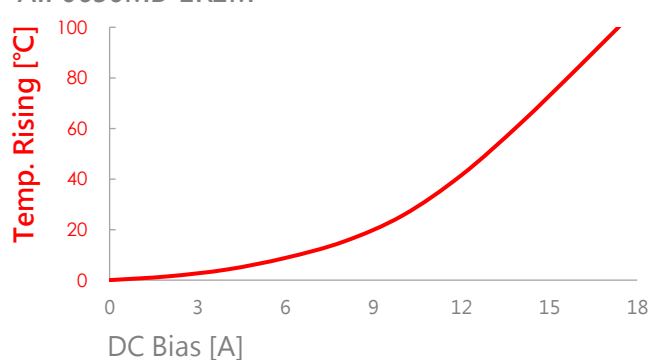
AIP0630MB-1R0M



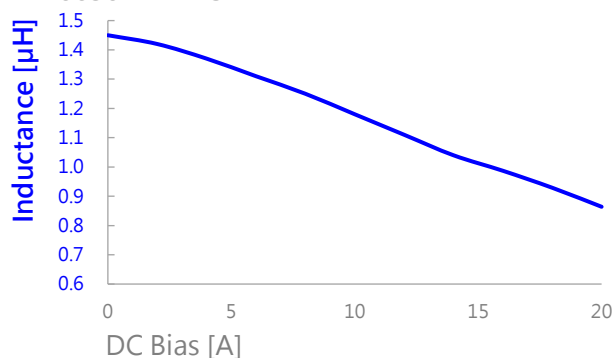
AIP0630MB-1R2M



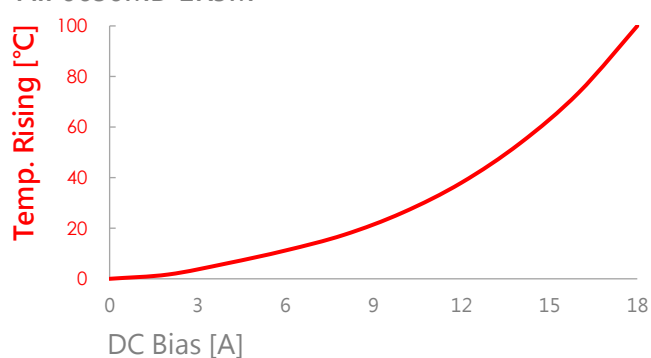
AIP0630MB-1R2M



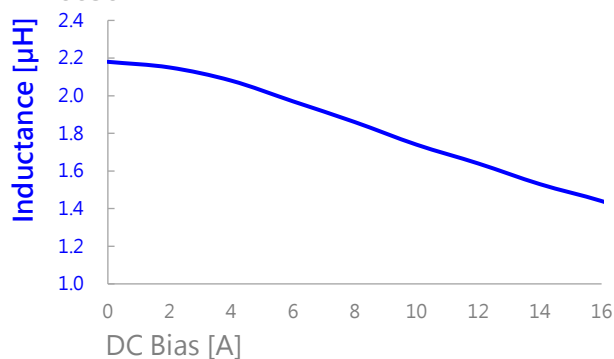
AIP0630MB-1R5M



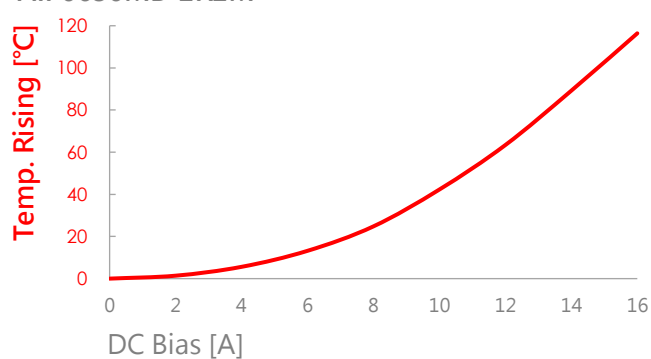
AIP0630MB-1R5M



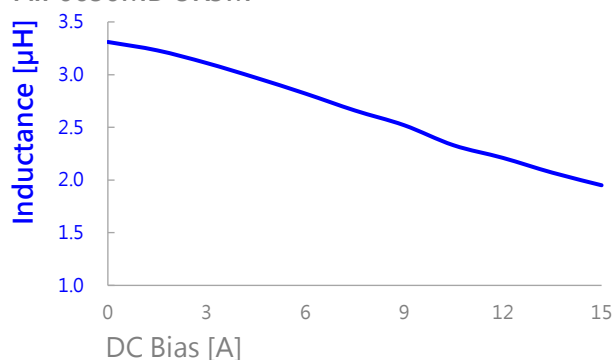
AIP0630MB-2R2M



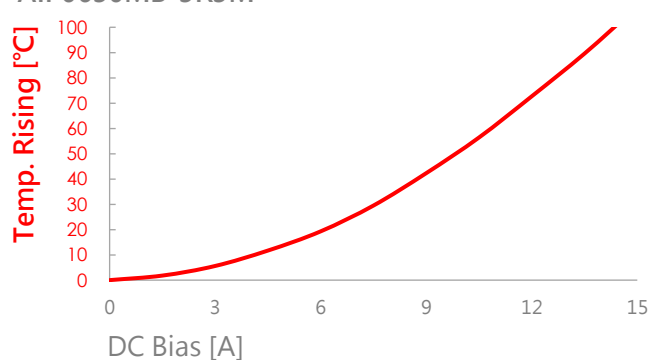
AIP0630MB-2R2M



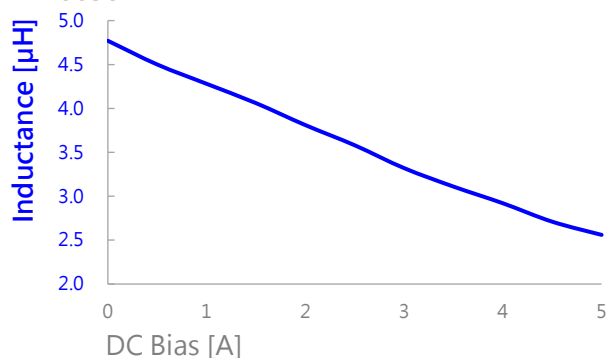
AIP0630MB-3R3M



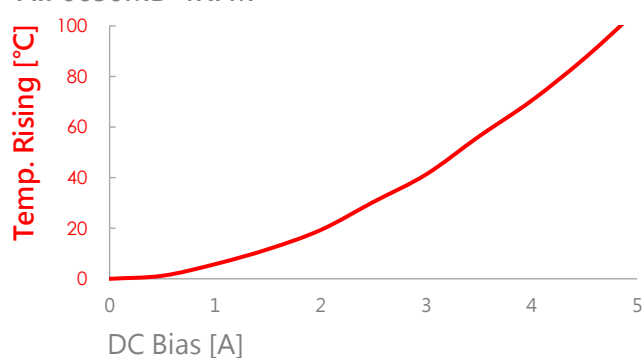
AIP0630MB-3R3M



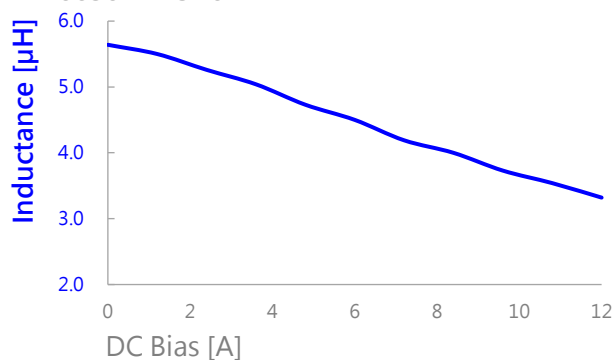
AIP0630MB-4R7M



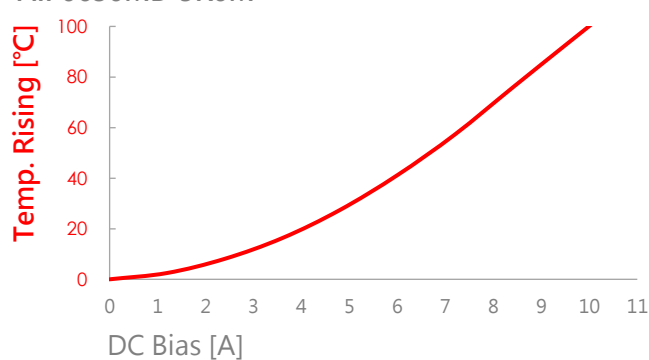
AIP0630MB-4R7M



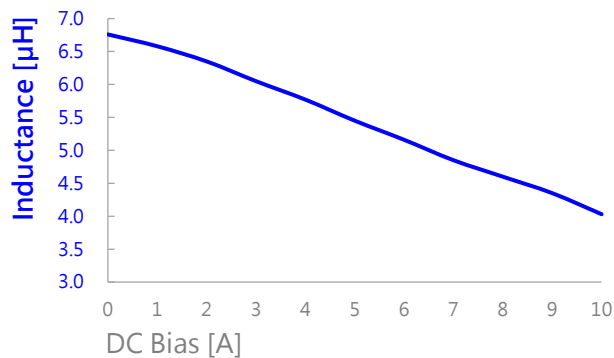
AIP0630MB-5R6M



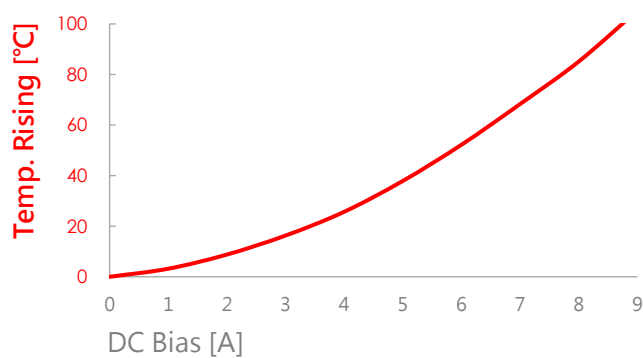
AIP0630MB-5R6M



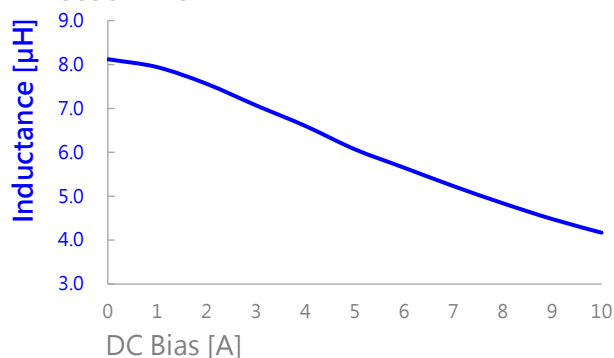
AIP0630MB-6R8M



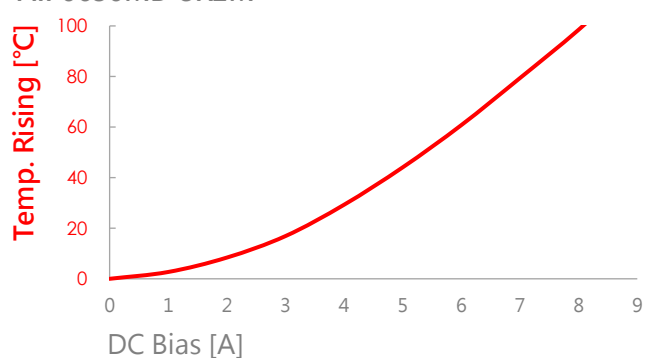
AIP0630MB-6R8M



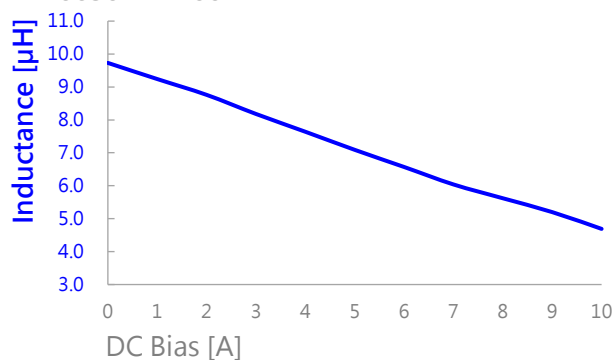
AIP0630MB-8R2M



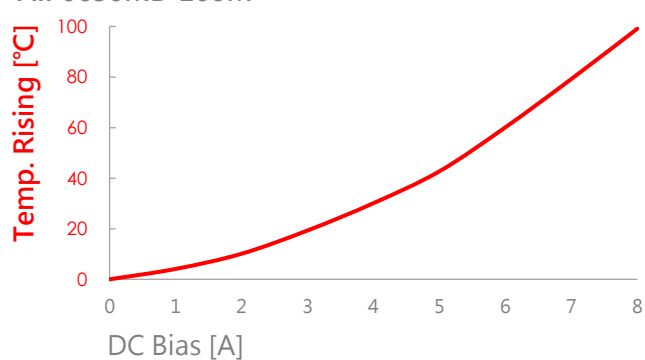
AIP0630MB-8R2M



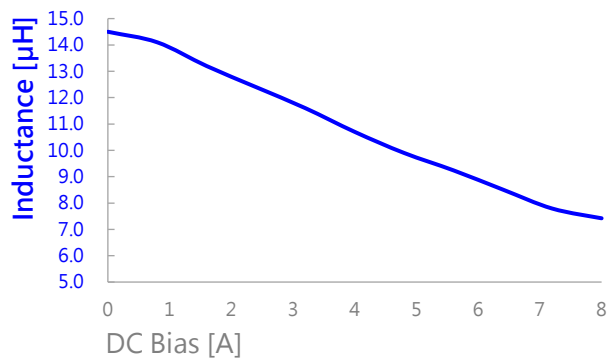
AIP0630MB-100M



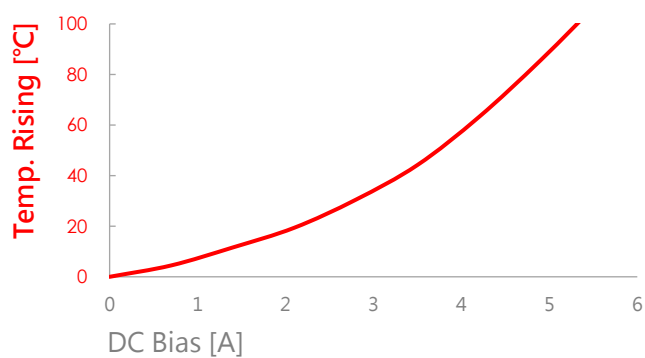
AIP0630MB-100M



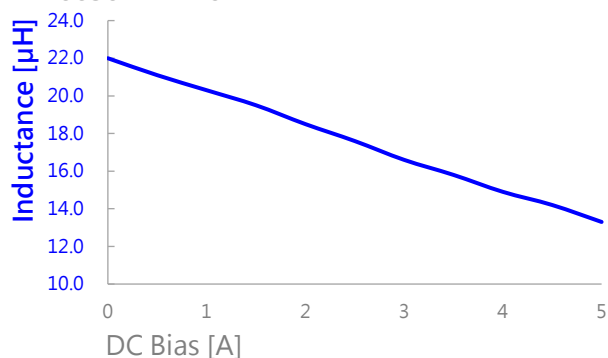
AIP0630MB-150M



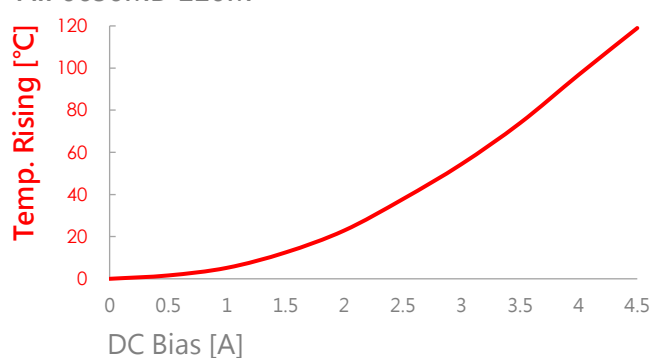
AIP0630MB-150M



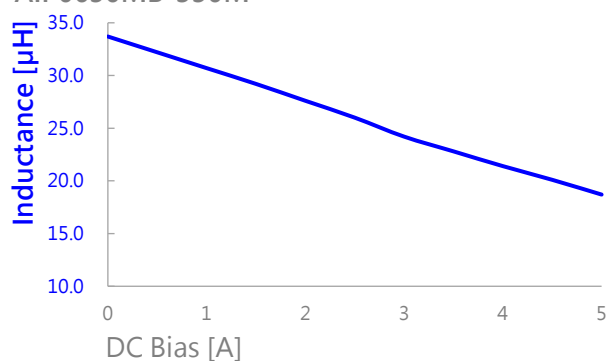
AIP0630MB-220M



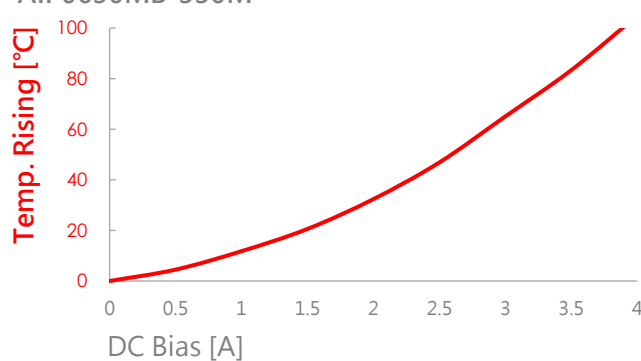
AIP0630MB-220M



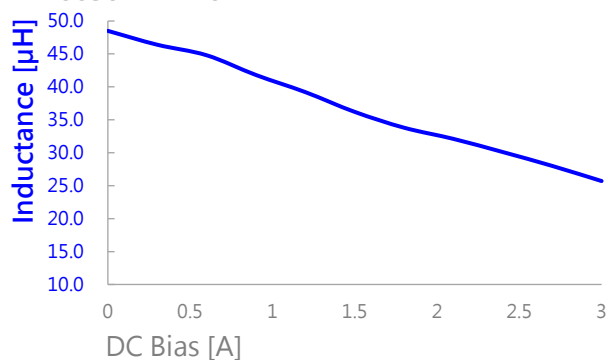
AIP0630MB-330M



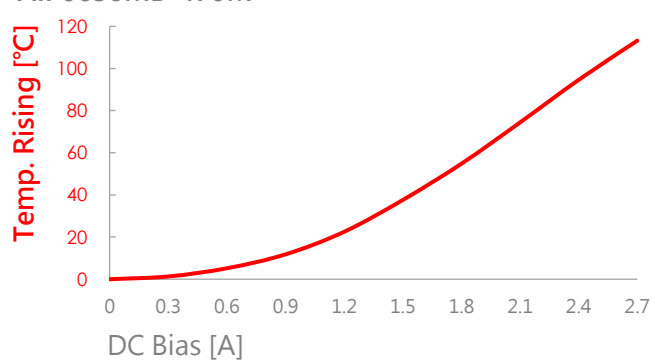
AIP0630MB-330M



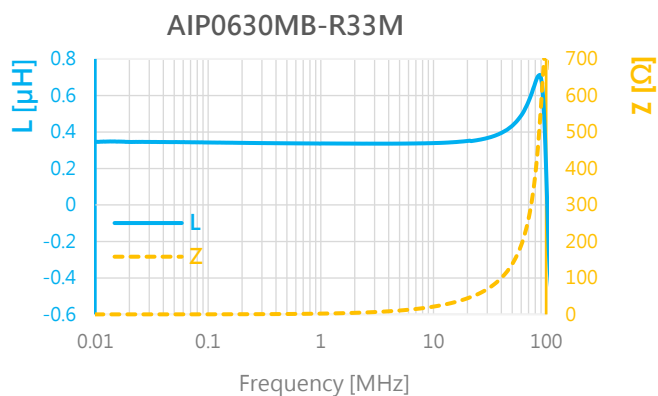
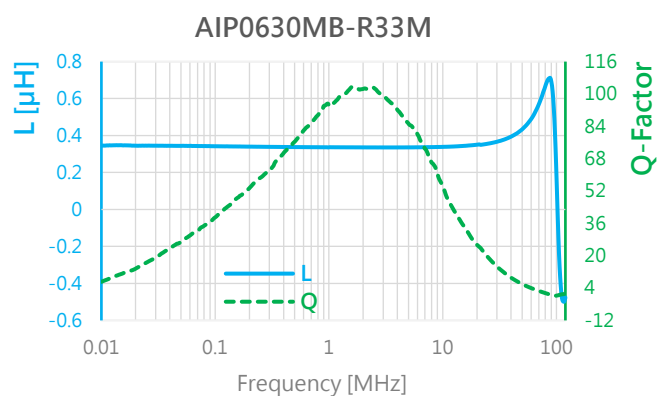
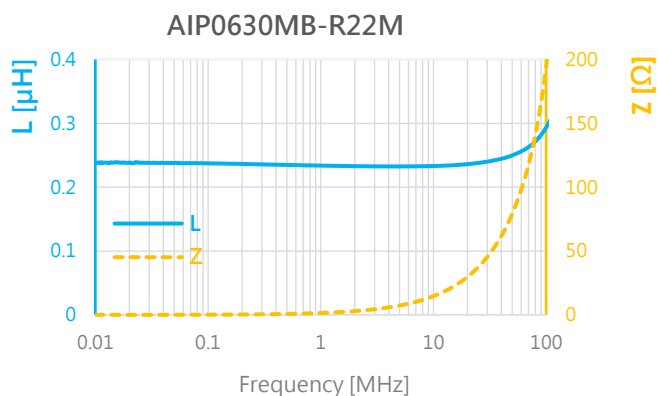
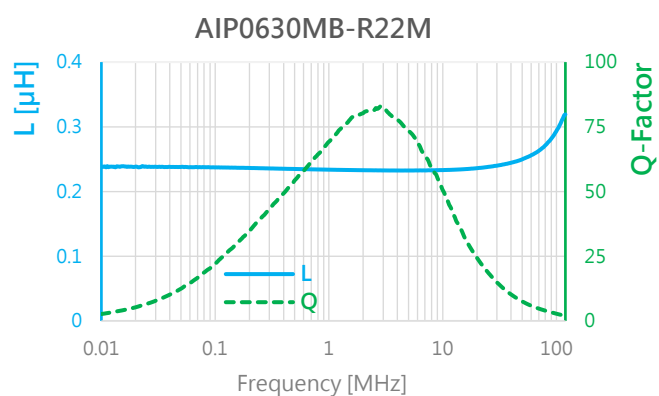
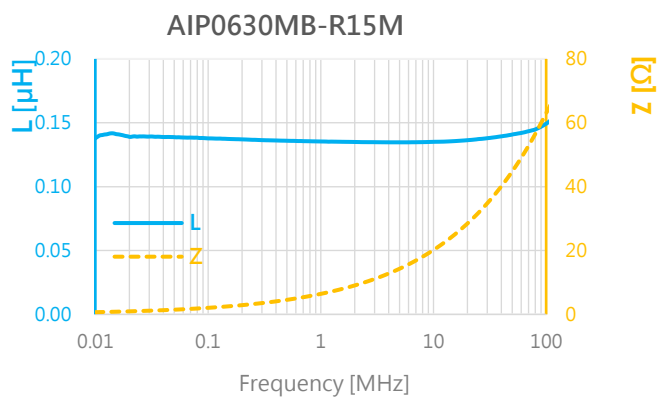
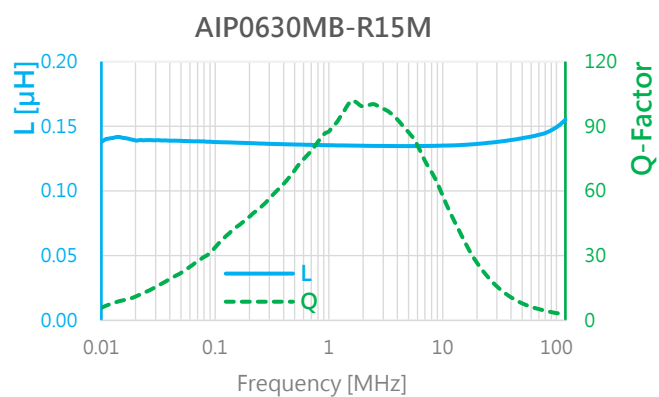
AIP0630MB-470M

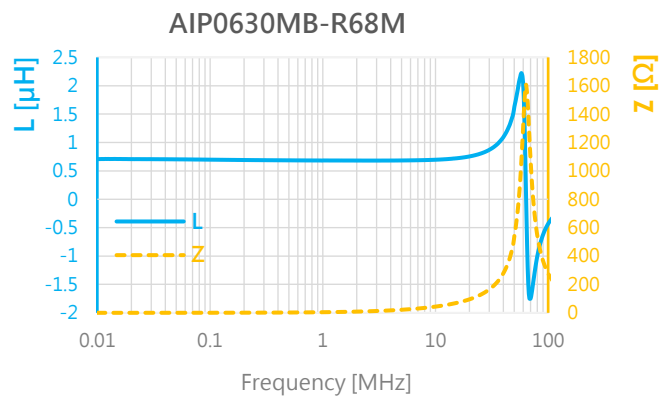
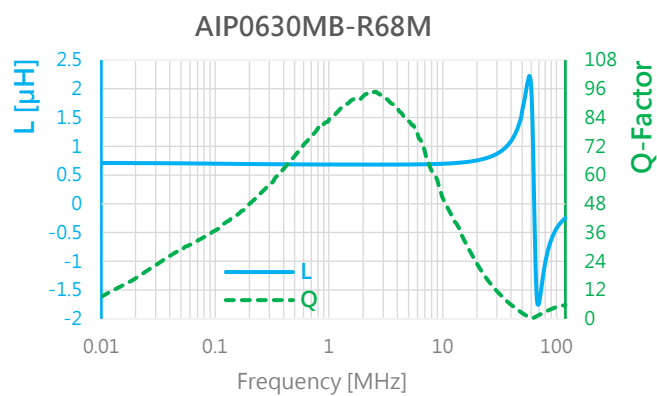
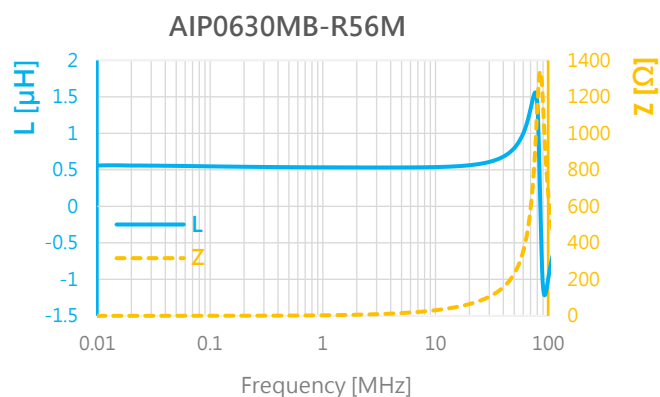
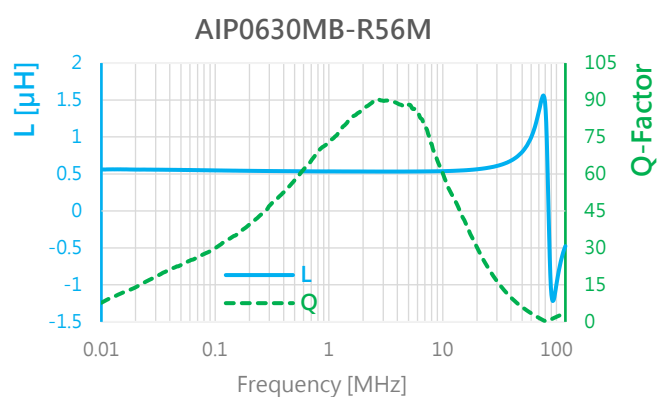
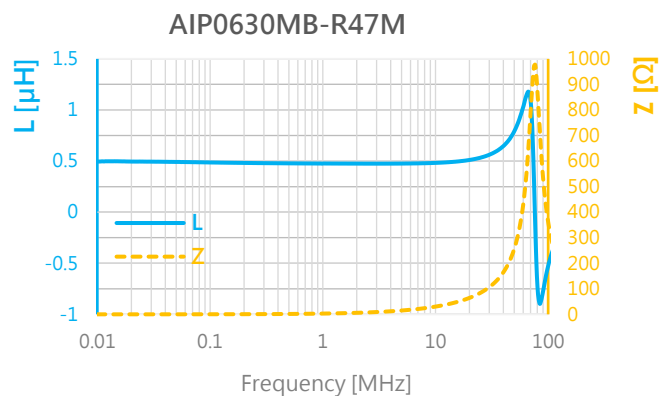
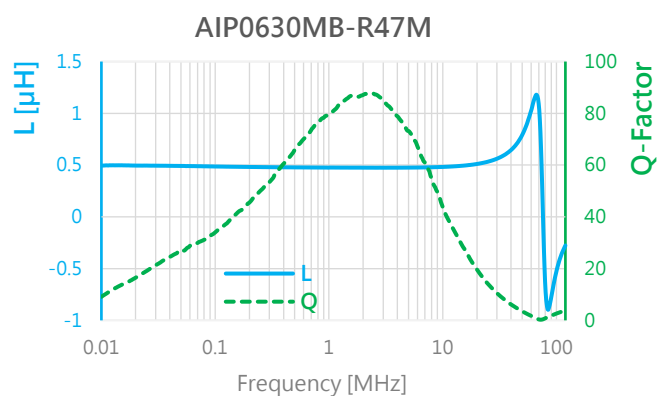


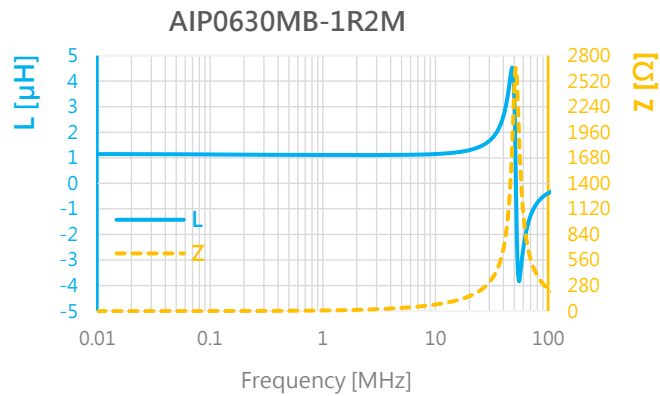
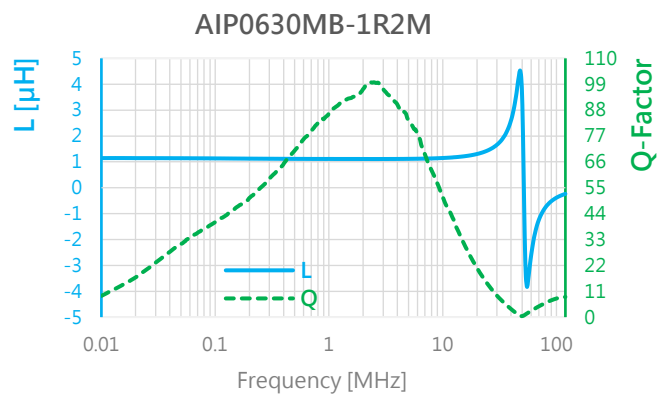
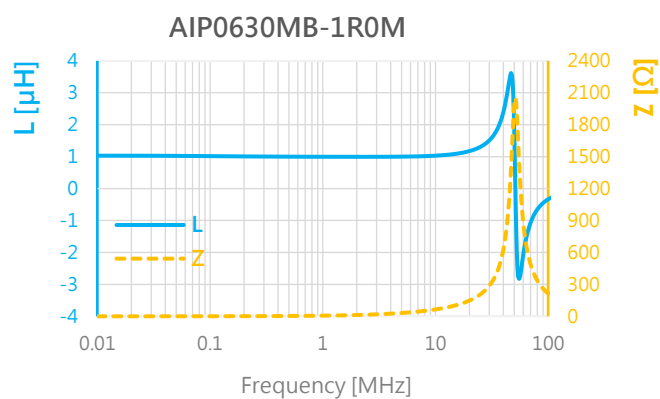
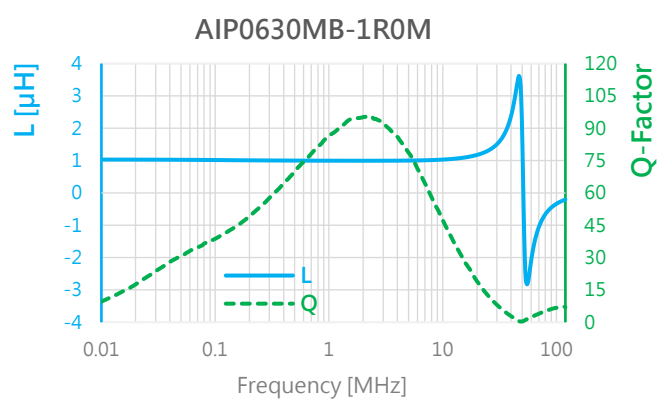
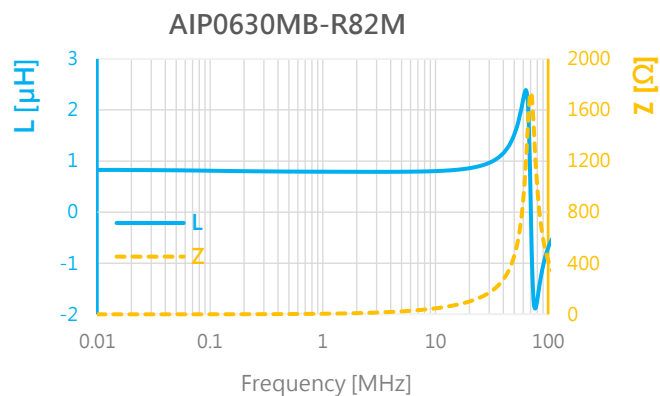
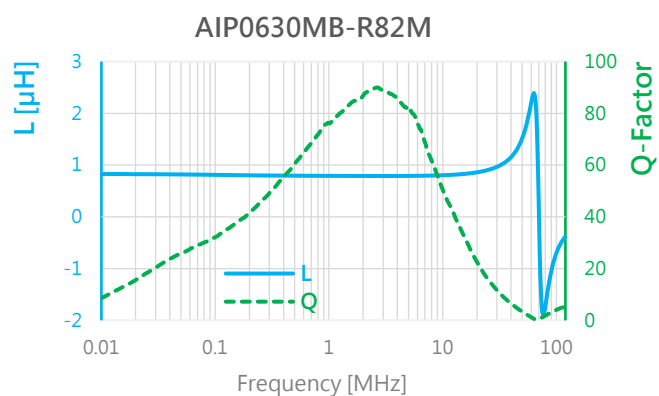
AIP0630MB-470M

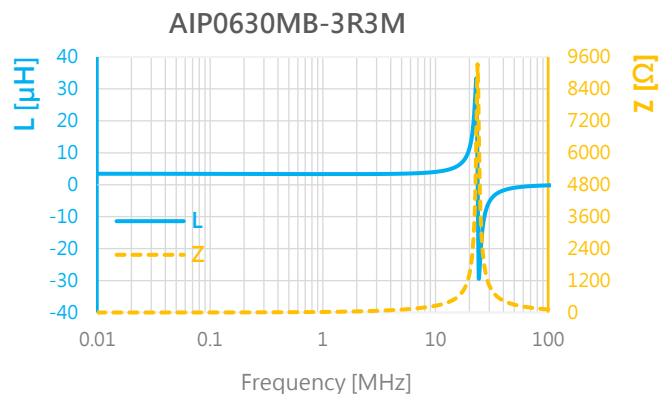
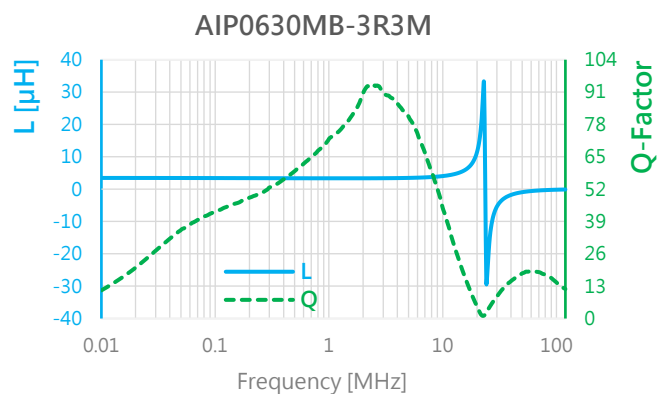
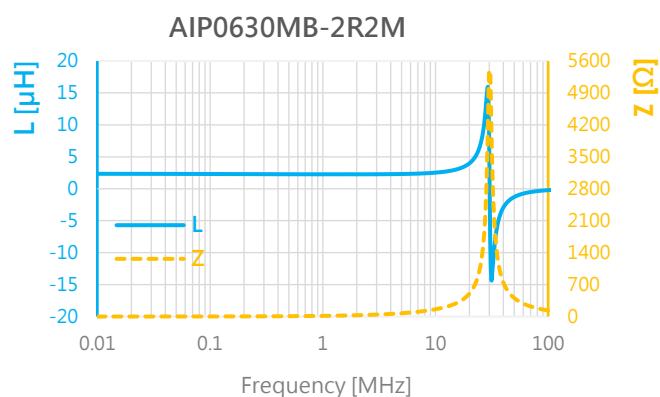
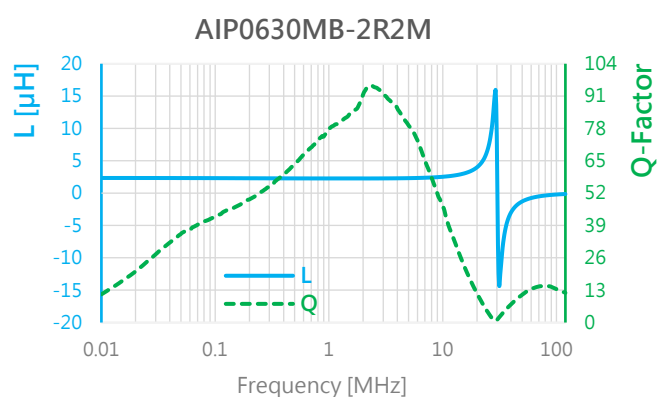
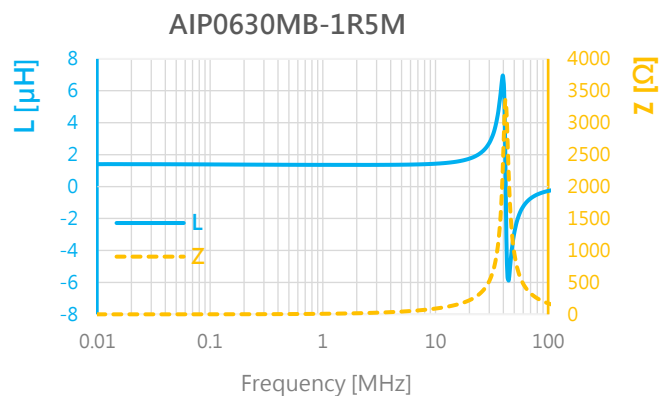
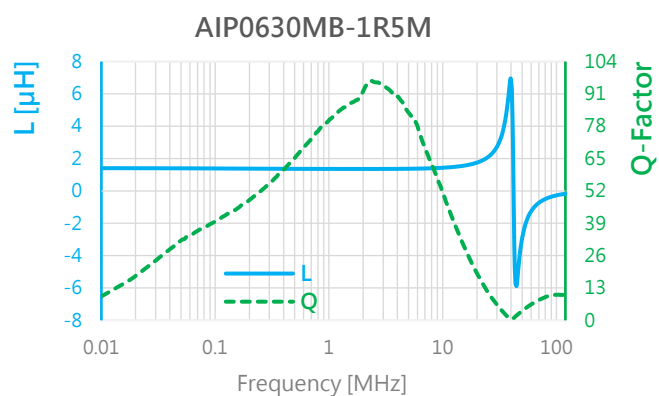


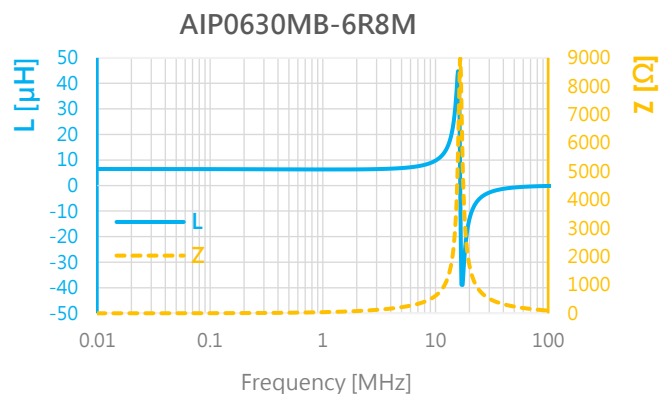
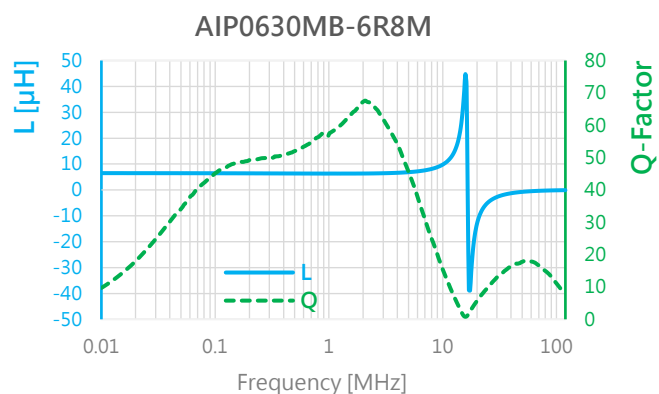
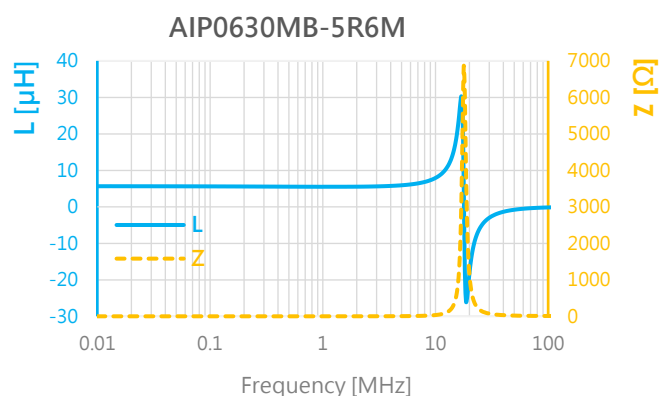
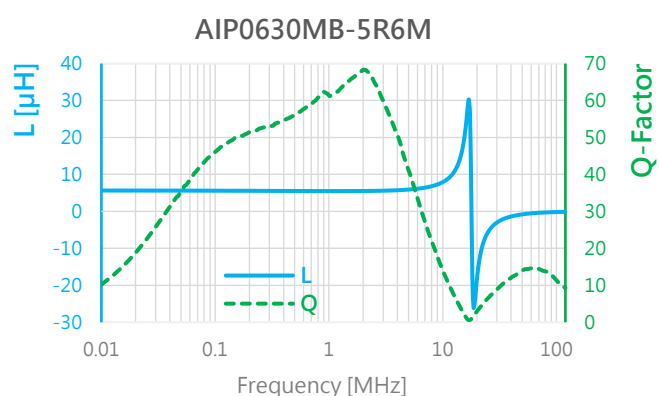
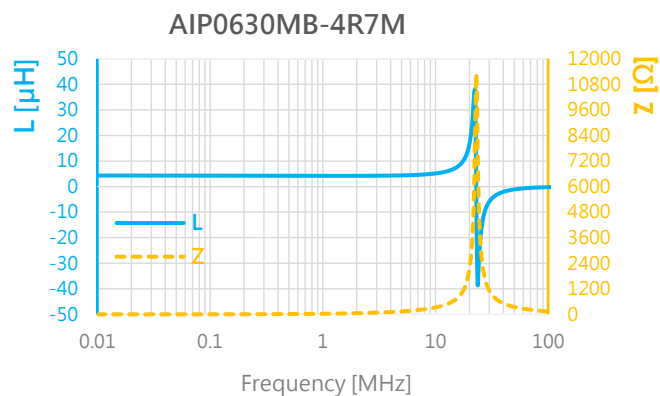
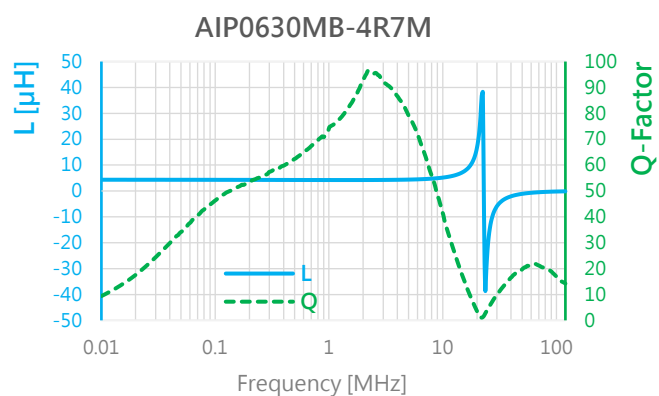
Inductance and Q vs. Frequency

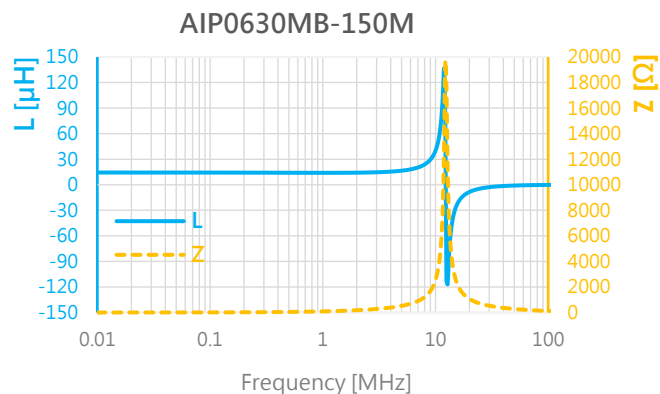
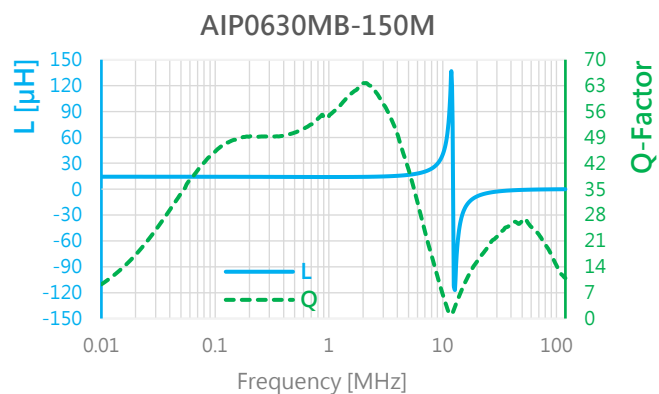
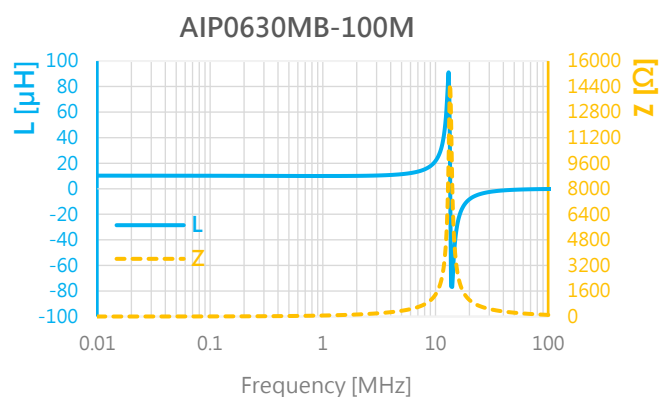
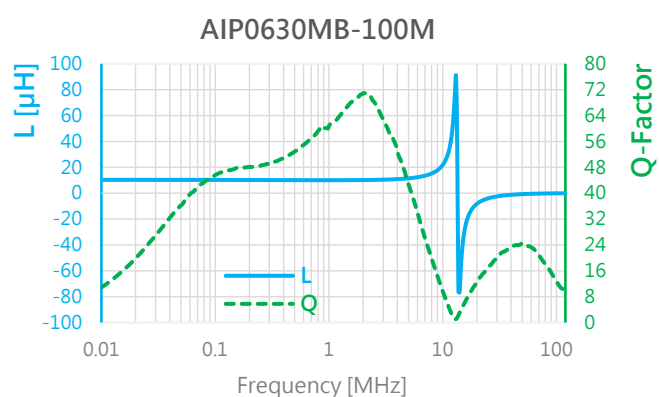
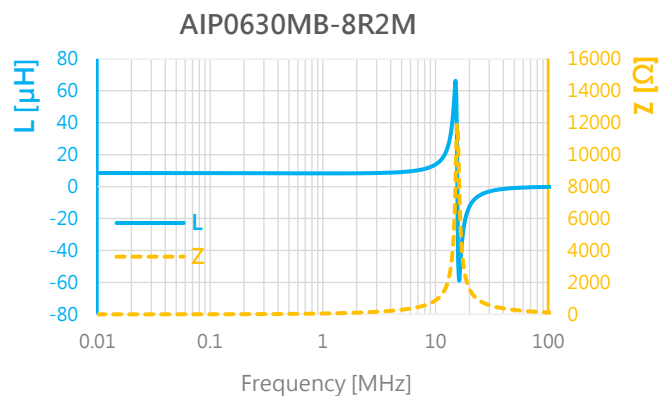
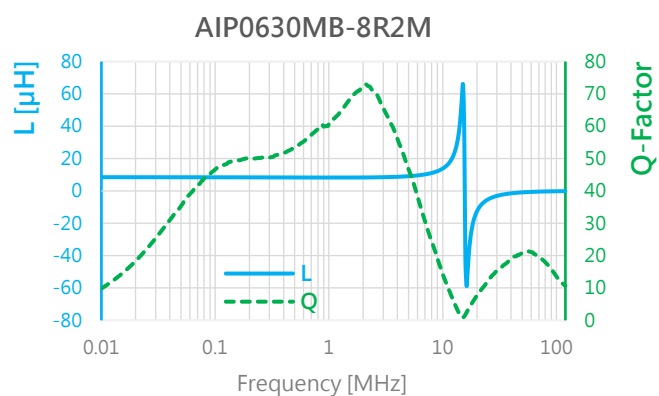


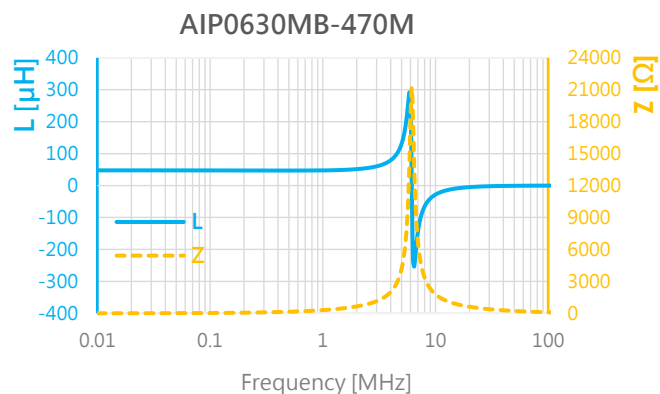
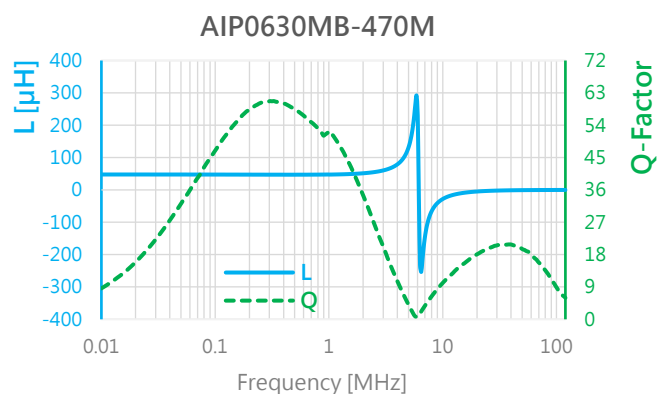
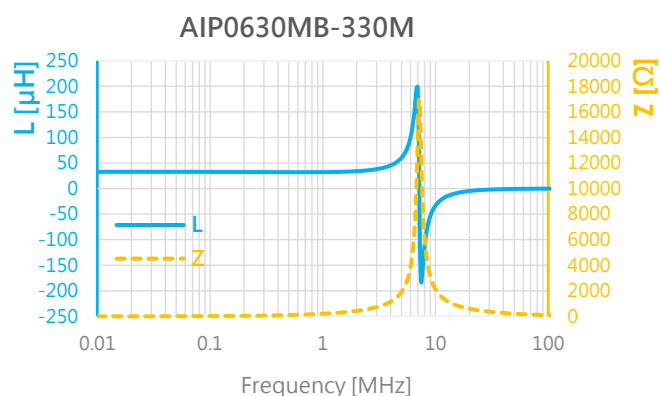
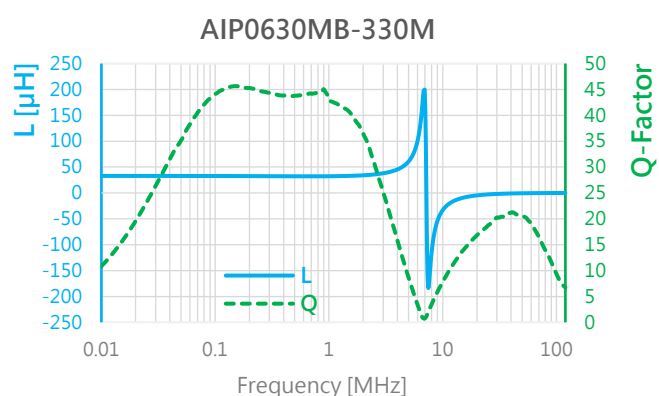
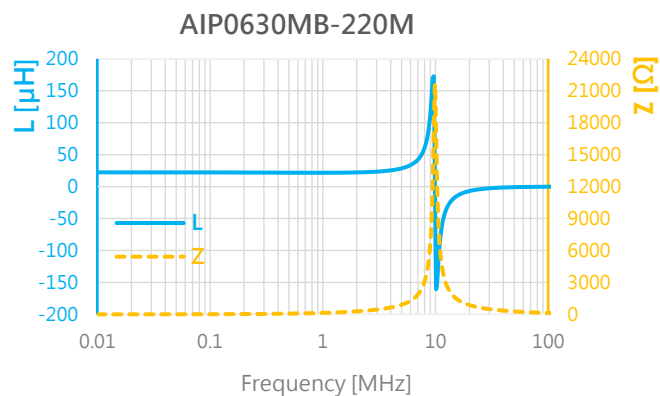
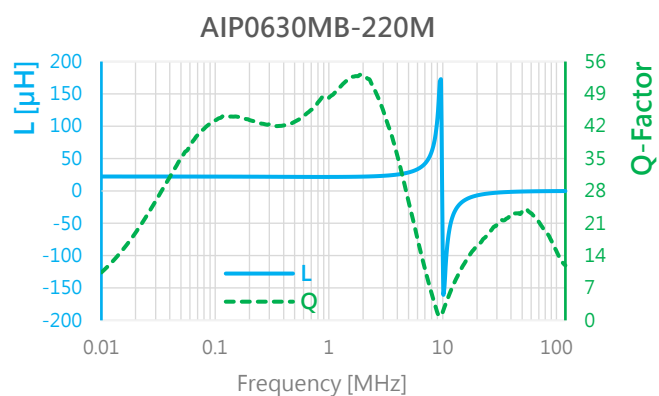












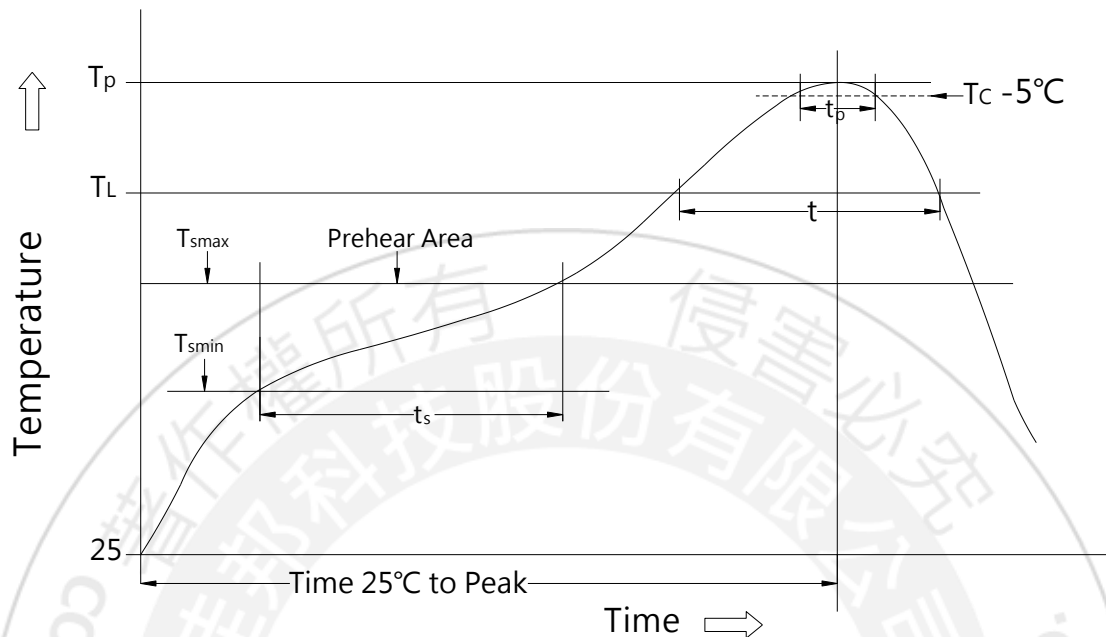
Mechanical Reliability

Item	Specification and Requirement	Test Method
Solderability	1. No case deformation or change in appearance. 2. New solder coverage More than 95%.	1. Preheat : 155 °C ± 5 °C, 60S ± 2S. 2. Tin : lead-free. 3. Temperature : 240 °C ± 5 °C, flux 3.0S ± 0.5S.
Mechanical shock	1. No case deformation or change in appearance. 2. $\Delta L / L_0 \leq \pm 10\%$.	1. Acceleration : 100G. 2. Pulse time : 6ms. 3. 3 times in each positive and negative direction of 3 mutual perpendicular directions.
Mechanical vibration	1. No case deformation or change in appearance. 2. $\Delta L / L_0 \leq \pm 10\%$.	1. Reflow : 2 times. 2. Frequency : 10Hz~55Hz ~ 10Hz, 20 min / cycles. 3. Amplitude : 1.52 mm. 4. Directions : X, Y, Z. 5. Time : 12 cycle / direction.

Endurance Reliability

Item	Specification and Requirement	Test Method
Thermal Shock	Inductance change : Within $\pm 10\%$ Without distinct damage in appearance.	1. First -55 °C for 30 minutes, last 125 °C for 30 minutes as 1 cycle. Go through 1000 cycles. 2. Max transfer time is 3 minutes. 3. Measured at room temperature after placing for 24 ± 2 hours.
Humidity Resistance	Inductance change : Within $\pm 10\%$ Without distinct damage in appearance.	1. Reflow 2 times. 2. 85 °C, 85% RH, 1000 hours. 3. Measured at room temperature after placing for 24 ± 2 hours.
Low temperature storage	Inductance change : Within $\pm 10\%$ Without distinct damage in appearance.	1. Temperature : -55 ± 2 °C. 2. Time : 1000 hours 3. Measured at room temperature after placing for 24 ± 2 hours.
High temperature storage	Inductance change : Within $\pm 10\%$ Without distinct damage in appearance.	1. Temperature : +125 ± 2 °C. 2. Time : 1000 hours. 3. Measured at room temperature after placing for 24 ± 2 hours.

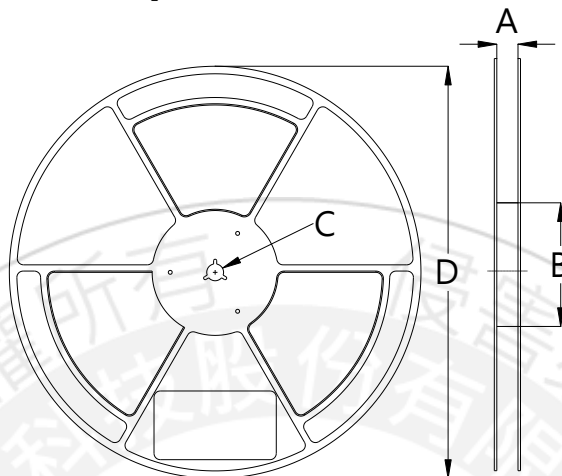
Recommendable Reflow Soldering



Profile Feature	Pb-Free Assembly
Preheat - Temperature Min(T_{smin}) - Temperature Max(T_{smax}) - Time (t_s) from (T_{smin} to T_{smax})	150°C 200°C 60-120 seconds
Ramp-up rate (T_L to T_P)	3°C / second max.
Liquidous temperature(T_L) Time (t) maintained above T_L	217°C 60-150 seconds
Peak package body temperature(T_P)	260°C +0/-5°C
Time within 5°C of actual peak temperature(t_p)	10-30 seconds
Ramp-down rate (T_P to T_L)	6°C / second max.
Time 25°C to peak temperature	8 minutes max.
Number of Reflow cycles allowed	2 cycles max.

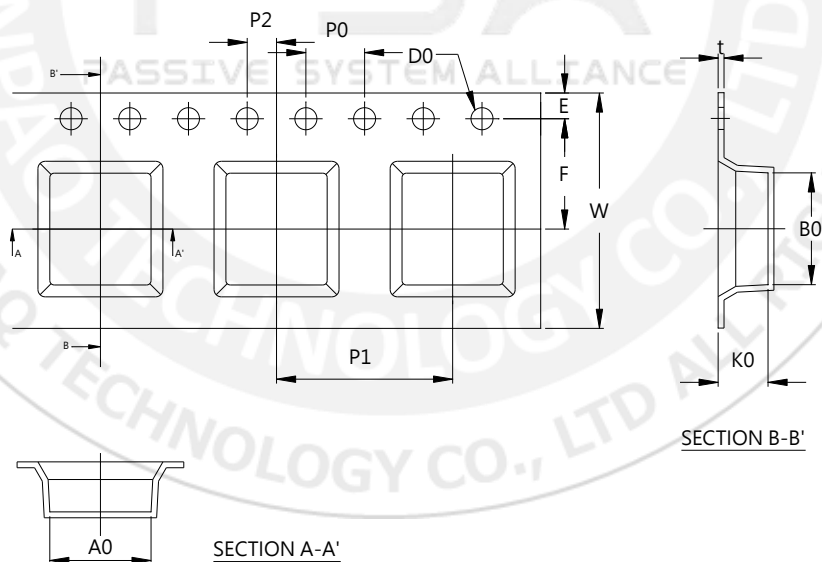
Tape & Reel

► Reel dimensions (unit: mm)



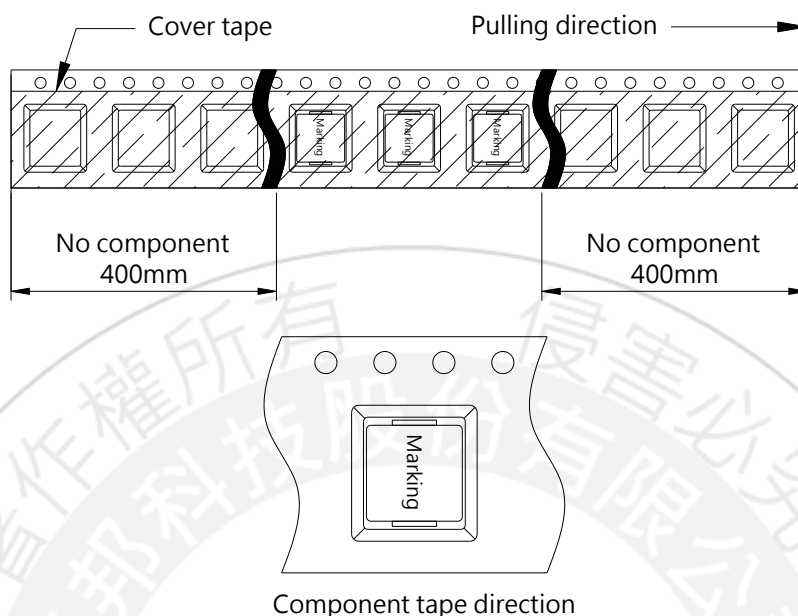
Type	A	B	C	D
13'x16	16.8+0.2	97+0.5	13.2±0.2	330+2.0

► Tape dimensions (unit: mm)



Type	W	P1	P0	P2	D0	t	A0	B0	K0	E	F
AIP0630MB	16 ±0.3	12 ±0.1	4 ±0.1	2 ±0.1	1.5 ±0.1	0.35 ±0.05	6.9 ±0.1	7.5 ±0.1	3.3 ±0.1	1.75 ±0.1	7.5 ±0.1

► Taping Drawings



► Taping Package Storage Condition

Storage Temperature: 5 to 40°C

Relative Humidity: < 65%RH

Storage Time: 12 months max

► Label Marking

The label specified as follows shall be put on the side of reel.

- (1) Part No.
- (2) Quantity.
- (3) Lot No.

* Part No. And Quantity shall be marked on outer packaging.

► Quantity of products in the package

Type	Reel
AIP0630MB	1500